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Jameco Part Number 1057383

### **SN65LBC175, SN75LBC175** QUADRUPLE LOW-POWER DIFFERENTIAL LINE RECEIVERS

SLLS171F - OCTOBER 1993 - REVISED NOVEMBER 2001

- Meets or Exceeds the EIA Standards RS-422-A, RS-423-A, RS-485, and CCITT Recommendation V.11
- **Designed to Operate With Pulse Durations** as Short as 20 ns
- **Designed for Multipoint Transmission on Long Bus Lines in Noisy Environments**
- Input Sensitivity . . . ±200 mV
- Low-Power Consumption . . . 20 mA Max
- Open-Circuit Fail-Safe Design
- Common-Mode Input Voltage Range of -7 V to 12 V
- Pin Compatible With SN75175 and LTC489

#### D, DW, OR N PACKAGE (TOP VIEW) 16 VCC 1В [ 1А Г 2 15 4B 3 1Y 🛮 14∏ 4A 1,2EN [] 4 13 **1** 4Y 2Y [ 5 123,4EN 11 3Y 2A 🛮 2B 🛮 7 10 3A 8 9**∏** 3B GND [

#### description

The SN65LBC175 and SN75LBC175 are monolithic, quadruple, differential line receivers with 3-state outputs designed to meet the requirements of the EIA standards RS-422-A, RS-423-A, RS-485, and CCITT Recommendation V.11. The devices are optimized for balanced multipoint bus transmission at data rates up to and exceeding 10 million bits per second. The receivers are enabled in pairs, with an active-high enable input. Each differential receiver input features high impedance, hysteresis for increased noise immunity, and sensitivity of ±200 mV over a common-mode input voltage range of 12 V to -7 V. The fail-safe design ensures that when the inputs are open-circuited, the outputs are always high. Both devices are designed using the TI proprietary LinBiCMOS™technology allowing low power consumption, high switching speeds, and robustness.

These devices offer optimum performance when used with the SN75LBC172 or SN75LBC174 quadruple line drivers. The SN65LBC175 is available in the 16-pin DIP (N), small-outline package (D), and the wide small-outline package (DW). The SN75LBC175 is available in the 16-pin DIP (N) and the small-outline package (D).

The SN65LBC175 is characterized over the industrial temperature range of -40°C to 85°C. The SN75LBC175 is characterized for operation over the commercial temperature range of 0°C to 70°C.

#### **AVAILABLE OPTIONS**

DACKACE	TEMPERATURE RANGE			
PACKAGE	0°C to 70°C	-40°C to 85°C		
SOIC	SN75LBC175D	SN65LBC175D		
Wide SOIC	_	SN65LBC175DW		
PDIP	SN75LBC175N	SN65LBC175N		



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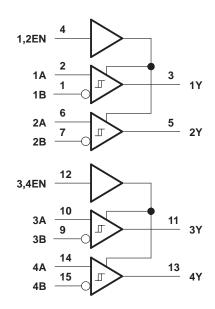


#### logic symbol†

#### 1,2EN ΕN ⅎ 1A 1Y 1 1B 2A 7 2Y 2B 12 3,4EN ΕN ⅎ 10 11 3A 3Y 9 3B 14 4A 13 15 4B

<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### logic diagram (positive logic)



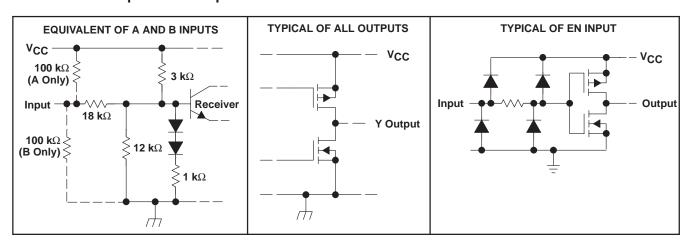
# FUNCTION TABLE (each receiver)

DIFFERENTIAL INPUTS A-B	ENABLE	OUTPUT Y		
V <sub>ID</sub> ≥ 0.2 V	Н	Н		
$-0.2 \text{ V} < \text{V}_{\text{ID}} < 0.2 \text{ V}$	Н	?		
$V_{ID} \le -0.2 V$	Н	L		
X	L	Z		
Open circuit	Н	Н		

H = high level, L = low level, X = irrelevant,

Z = high impedance (off), ? = indeterminate

#### schematics of inputs and outputs



# SN65LBC175, SN75LBC175 QUADRUPLE LOW-POWER DIFFERENTIAL LINE RECEIVERS

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage	e range, V <sub>CC</sub> (see Note 1)	$\dots \dots $
Input voltage, '	V <sub>I</sub> (A or B inputs)	±25 V
Differential inp	ut voltage, V <sub>ID</sub> (see Note 2)	±25 V
Voltage range	at Y, 1/2EN, 3/4EN	$-0.3$ V to V <sub>CC</sub> + $0.5$ V
Continuous tot	al dissipation	See Dissipation Rating Table
Operating free	-air temperature range, T <sub>A</sub> : SN65LBC175	–40°C to 85°C
	SN75LBC175	0°C to 70°C
Storage tempe	erature range, T <sub>stg</sub>	65°C to 150°C
Lead temperat	ture 1,6 mm (1/16 inch) from case for 10 seconds	3 260°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to GND.

2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.

#### **DISSIPATION RATING TABLE**

PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 85°C POWER RATING
D	1100 mW	8.7 mW/°C	709 mW	578 mW
DW	1200 mW	9.6 mW/°C	770 mW	625 mW
N	1150 mW	9.2 mW/°C	736 mW	598 mW

#### recommended operating conditions

				MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>			4.75	5	5.25	V	
Common-mode input voltage, V <sub>IC</sub>				-7		12	V
Differential input voltage, V <sub>ID</sub>				±6	V		
High-level input voltage, VIH	-N	EN inputs		2			V
Low-level input voltage, V <sub>IL</sub>	EN inputs					8.0	V
High-level output current, IOH						-8	mA
Low-level output current, I <sub>OL</sub>					8	mA	
On another for a sintense and a set of	SN65LBC17	75	•	-40		85	00
Operating free-air temperature, T <sub>A</sub>	SN75LBC17	75	•	0		70	°C

# SN65LBC175, SN75LBC175 QUADRUPLE LOW-POWER DIFFERENTIAL LINE RECEIVERS

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# electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP <sup>†</sup>	MAX	UNIT		
V <sub>IT+</sub>	Positive-going input three	shold voltage	$I_O = -8 \text{ mA}$				0.2	V	
VIT-	Negative-going input three	eshold voltage	IO = 8 mA			-0.2			V
V <sub>hys</sub>	Hysteresis voltage (VIT-	- VIT _)					45		mV
VIK	Enable input clamp volta	ge	$I_{I} = -18 \text{ mA}$				-0.9	-1.5	V
Vон	High-level output voltage		$V_{ID} = 200 \text{ mV},$	I <sub>OH</sub> = -8 m/	4	3.5	4.5		V
V <sub>OL</sub>	Low-level output voltage		$V_{ID} = -200 \text{ mV},$	$I_{OL} = 8 \text{ mA}$			0.3	0.5	V
I <sub>OZ</sub>	High-impedance-state ou	utput current	$V_O = 0 V \text{ to } V_{CC}$					±20	μΑ
	I <sub>I</sub> Bus input current A or B inputs		V <sub>IH</sub> = 12 V,	$V_{CC} = 5 V$	Other inputs at 0 V		0.7	1	
l.		A D :1-	V <sub>IH</sub> = 12 V,	$V_{CC} = 0 V$	Other inputs at 0 V		0.8	1	4
'		A or B inputs	$V_{IH} = -7 V$ ,	$V_{CC} = 5 V$	Other inputs at 0 V		-0.5	-0.8	mA
			$V_{IH} = -7 V$ ,	$V_{CC} = 0 V$	Other inputs at 0 V		-0.4	-0.8	
lн	High-level enable input c	urrent	V <sub>IH</sub> = 5 V				±20	μΑ	
IIL	Low-level enable input co	urrent	V <sub>IL</sub> = 0 V				-20	μΑ	
IOS	Short-circuit output curre	nt	V <sub>O</sub> = 0			-80	-120	mA	
loo	Complex company		Outputs enabled,	$I_{O} = 0$ ,	V <sub>ID</sub> = 5 V		11	20	mA
ICC Supply current		Outputs disabled				0.9	1.4	IIIA	

 $<sup>\</sup>frac{1}{1}$  All typical values are at V<sub>CC</sub> = 5 V and T<sub>A</sub> = 25°C.

## switching characteristics, $V_{CC}$ = 5 V, $C_L$ = 15 pF, $T_A$ = 25°C

	PARAMETER	TEST CONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT
tPHL	Propagation delay time, high- to low-level output	$V_{ID} = -1.5 \text{ V to } 1.5 \text{ V},$	11	22	30	ns
tPLH	Propagation delay time, low- to high-level output	See Figure 1	11	22	30	ns
<sup>t</sup> PZH	Output enable time to high level	See Figure 2		17	30	ns
tPZL	Output enable time to low level	See Figure 3		18	30	ns
tPHZ	Output disable time from high level	See Figure 2		30	40	ns
tPLZ	Output disable time from low level	See Figure 3		23	30	ns
t <sub>sk(p)</sub>	Pulse skew ( tpHL - tpLH )	See Figure 2		4	6	ns
t <sub>t</sub>	Transition time	See Figure 1		3	10	ns

#### PARAMETER MEASUREMENT INFORMATION

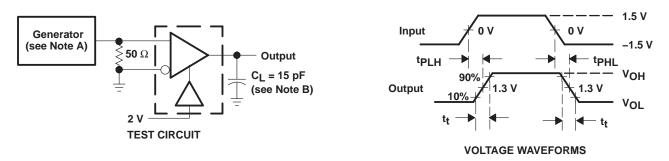
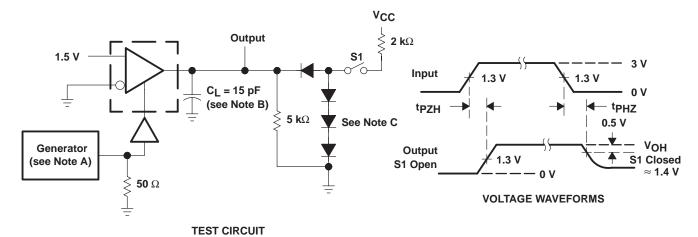


Figure 1. t<sub>PLH</sub> and t<sub>PHL</sub> Test Circuit and Voltage Waveforms

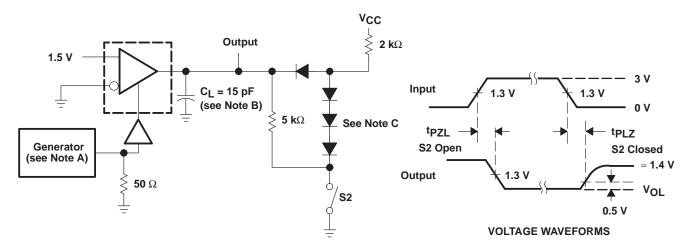


NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%,  $t_{\Gamma} \le 6$  ns,  $t_$ 

- B. CL includes probe and jig capacitance.
- C. All diodes are 1N916 or equivalent.

Figure 2. t<sub>PHZ</sub> and t<sub>PZH</sub> Test Circuit and Voltage Waveforms

#### PARAMETER MEASUREMENT INFORMATION



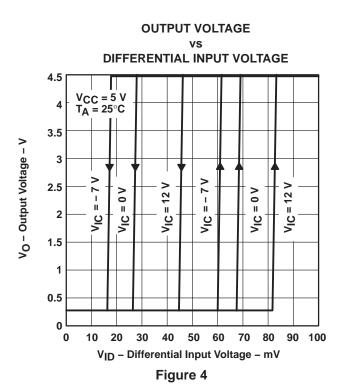
**TEST CIRCUIT** 

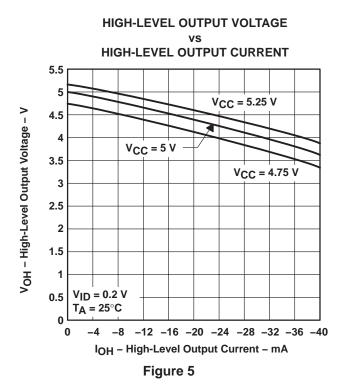
NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR = 1 MHz, duty cycle = 50%,  $t_r \le 6$  ns,  $t_f \le 6 \text{ ns}, Z_{\Omega} = 50 \Omega.$ 

- B. C<sub>L</sub> includes probe and jig capacitance.
- C. All diodes are 1N916 or equivalent.

Figure 3. tpzL and tpLZ Test Circuit and Voltage Waveforms

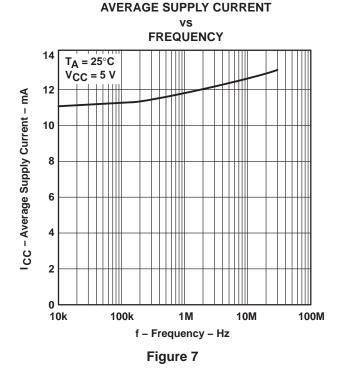
#### TYPICAL CHARACTERISTICS





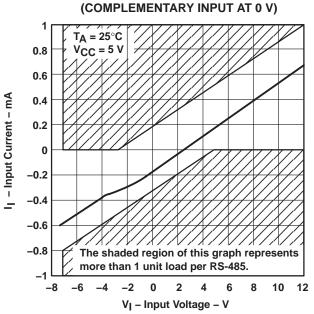
#### **TYPICAL CHARACTERISTICS**

#### LOW-LEVEL OUTPUT VOLTAGE LOW-LEVEL OUTPUT CURRENT 660 $T_A = 25^{\circ}C$ 600 V<sub>CC</sub> = 5 V V<sub>OL</sub> - Low-Level Output Voltage - mV V<sub>ID</sub> = 200 mV 540 480 420 360 300 240 180 120 60 0 18 0 15 21 24 27 30 12 IOL - Low-Level Output Current - mA



# INPUT CURRENT vs INPUT VOLTAGE (COMPLEMENTARY INPUT AT 0 V)

Figure 6



FREE-AIR TEMPERATURE 24.5 V<sub>C</sub>C = 5 V  $C_L = 15 pF$  $V_{10} = \pm 1.5 \text{ V}$ pd - Propagation Delay Time - ns 24 **tPHL** 23.5 23 <sup>t</sup>PLH 22.5 22 -40 -20 20 40 60 80 100  $T_A$  – Free-Air Temperature –  $^{\circ}C$ 

PROPAGATION DELAY TIME

Figure 8 Figure 9

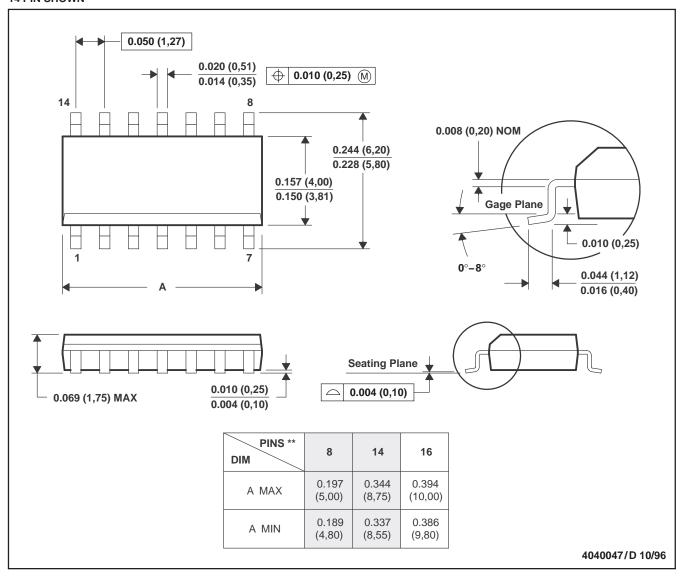
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#### **MECHANICAL DATA**

#### D (R-PDSO-G\*\*)

#### 14 PIN SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

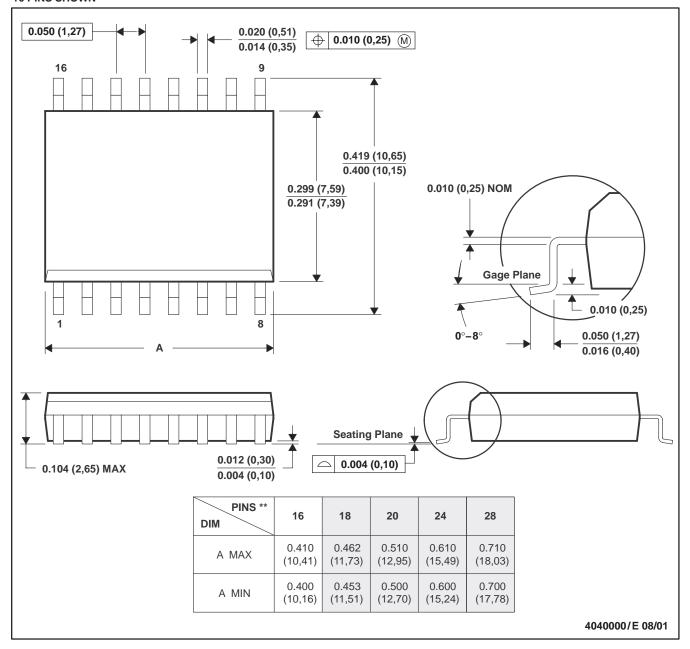
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#### **MECHANICAL DATA**

#### DW (R-PDSO-G\*\*)

#### 16 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013



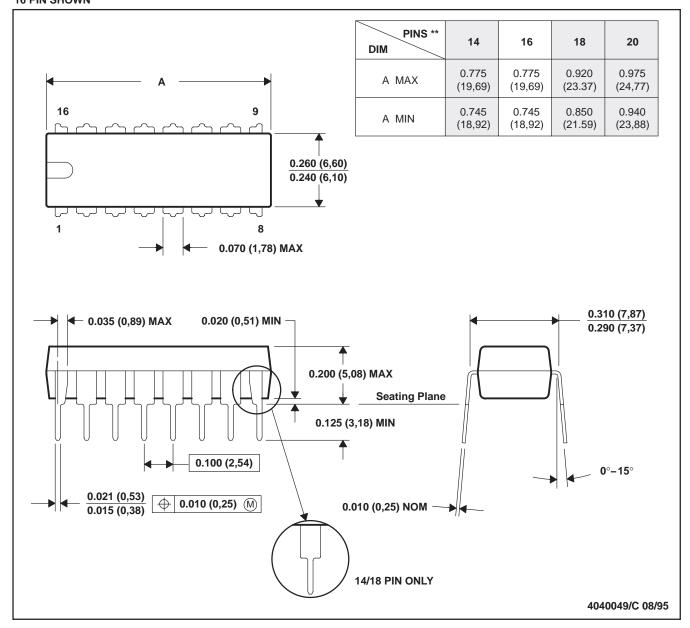
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#### **MECHANICAL DATA**

#### N (R-PDIP-T\*\*)

#### 16 PIN SHOWN

#### PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 (20 pin package is shorter then MS-001.)



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